03-29-1999

Form PTO-1595



## **VER SHEET**

U.S. Department of Commerce Patent and Trademark Office

Т	o the Honorable Commiss	sione 1	00998416	tached original documents or co	opy thereof	
οV	Name of conveying party(ies):			2. Name and address of receiving party(ies):		
5	Charles Dennison and Raymond Turi		Name: Micron Technology, Inc.			
1				Internal Address:		
	Additional name(s) of conveying Party(ies) attached?  Yes  x No			Internal Address:  Street Address:  8000 S. Federal Way		
3	party(les) attached:					
9	3. Nature of Conveyance:					
WE WE	X Assignment Merger			City: Boise		
	Security Agreer	nent Cha	ange of Name	State: <u>Idaho</u> Zip: <u>83707-0006</u>		
	Other  Execution Date(s): March 15, 1999			Country:		
				Additional name(s) & Yes address(es) attached? x No		
ļ	4. Application number(s) or patent number(s):			09/268,737		
	If this document is being filed together with a new application,					
	the Execution date(s) of the new application is (are):  A. Patent Application No.(s):			3/15/99;		
				B. Patent No.(s):		
				Additional numbers attached? Yes X No		
	<ol> <li>Name and address of party to whom correspondence concerning document should be mailed:</li> <li>Name: DICKSTEIN SHAPIRO MORIN &amp; OSHINSKY LLP</li> <li>Internal Address: Atty. Dkt.: M4065.079/P079</li> </ol>			6. Total number of applications and patents involved:		
				7. Total fee (37 C.F.R 3.41) \$ \$40.00		
				<del>x</del> Enclosed		
	Attn: Thomas J. D'Amico  Street Address: 2101 L Street, NW		Authorized to be charged to deposit account			
			NW	x Credit any overpayment or		
	Officer / tadi coo.			debit any underpayment		
	City: <b>Washington</b>		Zip: <b>20037-1526</b>	8. Deposit account number: 04-	1073	
03/29/1999 DNGU	YEN 00000067 041073	09268737	DO NOT USE	THIS SPACE		
01 FC:581	9. Statement and signature.  To the best of my knowledge and belief, the foregeing information is true and correct and any attached copy is a true copy of the original document.  Thomas J. D'Amico  Signature  DO NOT USE THIS SPACE  March 17, 1999  Date					
	Reg. No. 28,3	eg. No. 28,371				
	Total number of pages including cover sheet, attachments, and document: 4					

PATENT REEL: 9837 FRAME: 0466

Docket No.: M4065.079/P079 Micron No.: 98-0344.00/US

## ASSIGNMENT AND AGREEMENT

For value received, we, Charles H. Dennison and Raymond A. Turi of Boise, ID, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled METHOD OF FORMING DUAL CONDUCTIVE PLUGS described in an application for Letters Patent of the United States, executed by us of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United State for said inventions; and we also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

PATENT REEL: 9837 FRAME: 0467

Docket No.: M4065.079/P079 Micron No.: 98-0344.00/US

We agree that, when requested, we shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Chew H Dennison
Charles H. Dennison

Date: 3-15-99

United States of America )
State of <u>Qdaho</u> )ss.:
County of <u>Qda</u> )

On this 15 day of March, 1998, before me personally came Charles H. Dennison, to me known to be the individual described in and who executed the foregoing instrument, and acknowledged execution of the same.

AUBLIC OF IDAKING

Notary Public

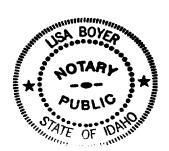
Docket No.: M4065.079/P079 Micron No.: 98-0344.00/US

Raymond A. Turi

Date: 3 - 15 - 99

United States of America )
State of \_\_\_\_\_\_\_ )ss.:
County of \_\_\_\_\_\_ )

On this \_\_\_\_\_\_\_, 1998, before me personally came Raymond A Turi, to me known to be the individual described in and who executed the foregoing instrument, and acknowledged execution of the same.



Notary Public